

# ANTREX Electronics

## Electronic Components Sourcing Information

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### Product Reference Information

|                      |                                 |
|----------------------|---------------------------------|
| <b>Part Number:</b>  | 2SK0601G0L                      |
| <b>Manufacturer:</b> | Panasonic Electronic Components |
| <b>Package:</b>      | Please confirm with sales       |
| <b>Availability:</b> | Please confirm with sales       |

**Product Page:**

<https://antrexco.com/product/details/panasonic-electronic-components/2sk0601g0l.html>

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**Note:**

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

# 2SK0601 (2SK601)

## Silicon N-channel MOSFET

For switching circuits

### ■ Features

- Low drain-source ON resistance  $R_{DS(on)}$
- High-speed switching
- Allowing to be driven directly by CMOS and TTL
- Mini-power type package, allowing downsizing of the sets and automatic insertion through the tape/magazine packing.

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter                        | Symbol    | Rating      | Unit             |
|----------------------------------|-----------|-------------|------------------|
| Drain-source voltage             | $V_{DS}$  | 80          | V                |
| Gate-source voltage (Drain open) | $V_{GSO}$ | 20          | V                |
| Drain current                    | $I_D$     | 0.5         | A                |
| Peak drain current               | $I_{DP}$  | 1.0         | A                |
| Power dissipation *              | $P_D$     | 1           | W                |
| Channel temperature              | $T_{ch}$  | 150         | $^\circ\text{C}$ |
| Storage temperature              | $T_{stg}$ | -55 to +150 | $^\circ\text{C}$ |

Note) \*: PC board: Copper foil of the drain portion should have a area of 1 cm<sup>2</sup> or more and the board thickness should be 1.7 mm.

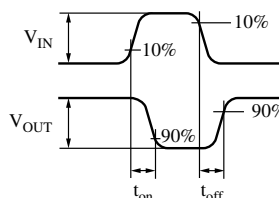
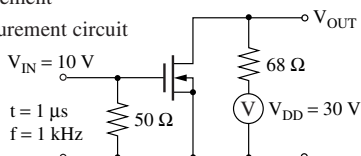
### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

| Parameter                                                  | Symbol       | Conditions                                                            | Min | Typ | Max | Unit          |
|------------------------------------------------------------|--------------|-----------------------------------------------------------------------|-----|-----|-----|---------------|
| Drain-source surrender voltage                             | $V_{DSS}$    | $I_{DS} = 100 \mu\text{A}$ , $V_{GS} = 0$                             | 80  |     |     | V             |
| Drain-source cutoff current                                | $I_{DSS}$    | $V_{DS} = 60 \text{ V}$ , $V_{GS} = 0$                                |     |     | 10  | $\mu\text{A}$ |
| Gate-source cutoff current                                 | $I_{GSS}$    | $V_{GS} = 20 \text{ V}$ , $V_{DS} = 0$                                |     |     | 0.1 | $\mu\text{A}$ |
| Gate threshold voltage                                     | $V_{th}$     | $I_D = 1 \text{ mA}$ , $V_{DS} = V_{GS}$                              | 1.5 |     | 3.5 | V             |
| Drain-source ON resistance *1                              | $R_{DS(on)}$ | $I_D = 0.5 \text{ A}$ , $V_{GS} = 10 \text{ V}$                       |     | 2   | 4   | $\Omega$      |
| Forward transfer admittance                                | $ Y_{fs} $   | $I_D = 0.2 \text{ A}$ , $V_{DS} = 15 \text{ V}$ , $f = 1 \text{ kHz}$ |     | 300 |     | mS            |
| Short-circuit forward transfer capacitance (Common source) | $C_{iss}$    | $V_{DS} = 10 \text{ V}$ , $V_{GS} = 0$ , $f = 1 \text{ MHz}$          |     | 45  |     | pF            |
| Short-circuit output capacitance (Common source)           | $C_{oss}$    |                                                                       |     | 30  |     | pF            |
| Reverse transfer capacitance (Common source)               | $C_{rss}$    |                                                                       |     | 8   |     | pF            |
| Turn-on time *2                                            | $t_{on}$     |                                                                       |     | 15  |     | ns            |
| Turn-off time *2                                           | $t_{off}$    |                                                                       |     | 20  |     | ns            |

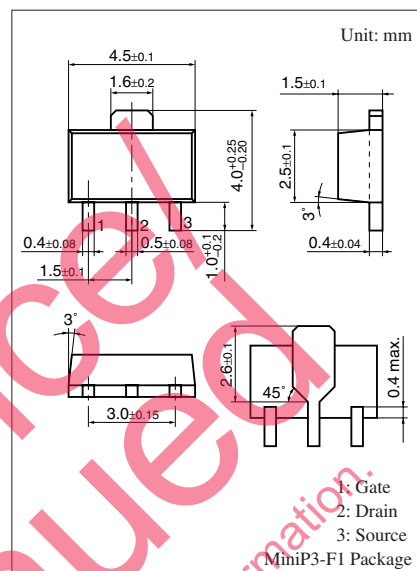
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*1: Pulse measurement

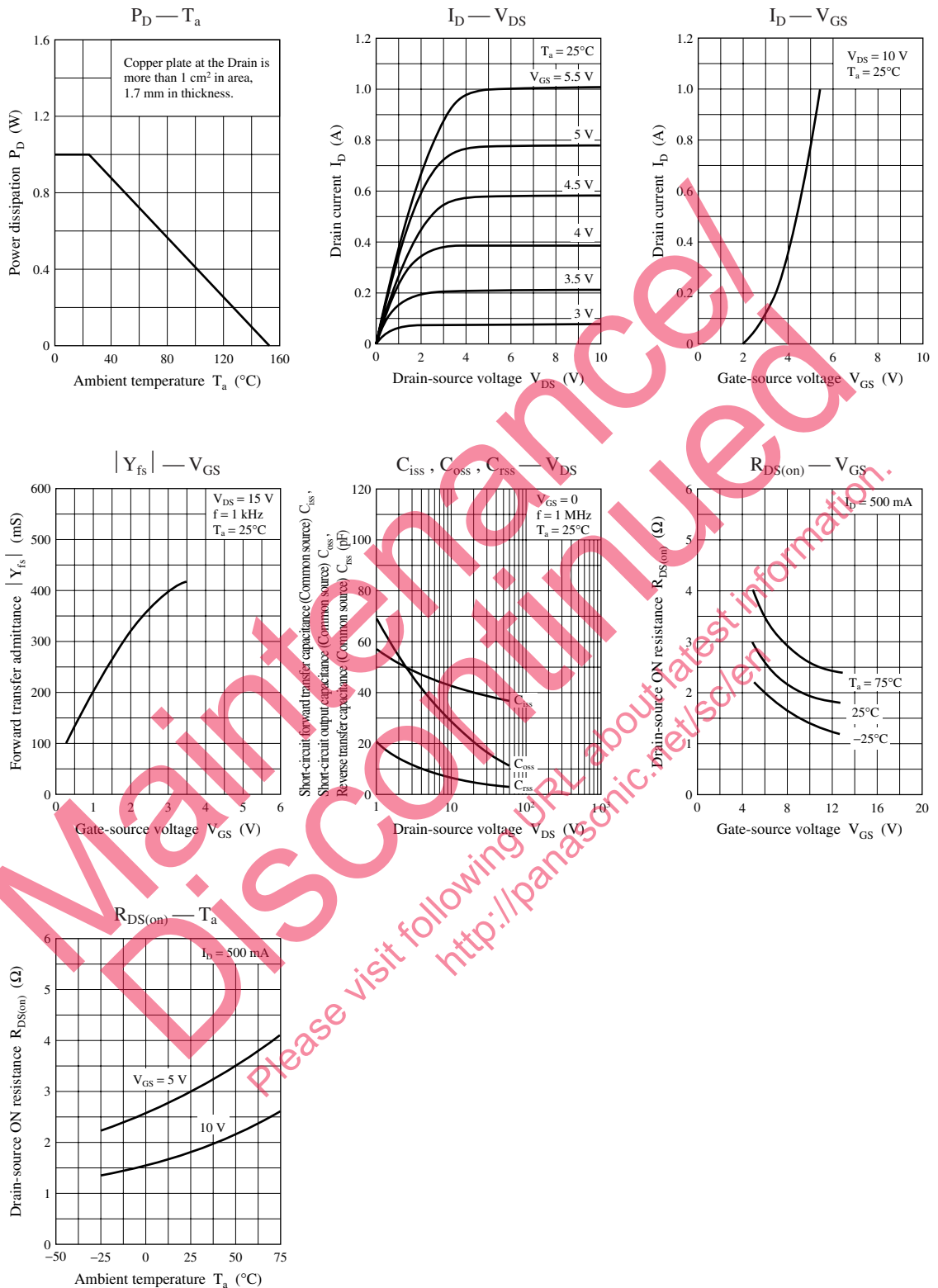
\*2:  $t_{on}$ ,  $t_{off}$  measurement circuit



Note) The part number in the parenthesis shows conventional part number.



Marking Symbol: Q



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